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Attorney Docket : 033036 M 156

1. Name of conveying party(ies):

Kenya TACHIBANA
Masahiro WADA
Takuya HATAO

Additional name of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: SUMITOMO BAKELITE COMPANY LIMITED

Street Address: 5-8, Higashi-Shinagawa 2-chome,
Shinagawa-ku, Tokyo, JAPAN

Additional Name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: **November 28, 2008**

4. Application number(s) or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning this document should be mailed:

Name: **Michael A. Makuch**

Internal Address: **SMITH, GAMBRELL & RUSSELL, LLP**

Street Address: **1130 Connecticut Avenue - Suite 1130**

City: **Washington** State: **DC** Zip: **20036**

6. Total number of applications and patents involved: - 1 -

7. Total fee (37 CFR 3.41) \$40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

02-4300

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Michael A. Makuch

Name of Person Signing

Signature

January 7, 2009

Date

Total number of pages including cover sheet, attachments, and documents: - 3 -

Mail documents to be recorded with required cover sheet information to:
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PATENT
REEL: 022096 FRAME: 0623

PCT-13317
12/309110

SGR/BDWY Form ASN-1
Inventor(s)-to-Assignee

ASSIGNMENT

This assignment agreement is applicable to an invention entitled:
CONNECTING STRUCTURE FOR FLIP-CHIP SEMICONDUCTOR PACKAGE, BUILD-UP
LAYER MATERIAL, SEALING RESIN COMPOSITION, AND CIRCUIT BOARD

The PATENT RIGHTS referred to in this agreement are:

- (check one) a patent application for this invention, executed by the ASSIGN OR(S) concurrently with this assignment.
- U.S. patent application Serial No. _____ filed _____.
- a U.S. patent application based on PCT International Application No. PCT/JP2008/056069 filed on 03/28/2008, U.S. patent application Serial No. _____, if known).
- U.S. patent No. _____, issued _____.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

- (check one) U.S. patent rights only.
- Worldwide patent rights. In this case, the assignee shall have the right to claim the benefit of the filing date of any U.S. or foreign patent application for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEES referred to in this agreement are:

(Name of Assignee) SUMITOMO BAKELITE CO., LTD.
(Address) 5-8, Higashi-Shinagawa 2-chome, Shinagawa-ku, Tokyo, Japan

The ASSIGNEE is:

- (check one) An Individual.
- A Partnership.
- A Corporation of Japan (specify state or country)
- (other)

The ASSIGNOR(S), receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEES, their successors and assigns:

the full and exclusive right to the invention;
the entire right, title and interest in and to the PATENT RIGHTS;
the right to sue and recover for any past infringement; and,
the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions,
based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEES as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEES, their successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEES, or their representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEES, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEES, their successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNORS authorize any attorneys and agents who have a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

| | | |
|--------------------------------|------------------------|--------------------------|
| <u>Kenya TACHIBANA</u> | <i>Kenya Tachibana</i> | <u>November 28, 2008</u> |
| Name of sole or first inventor | Signature | Date |
| <u>Masahiro WADA</u> | <i>Masahiro Wada</i> | <u>November 28, 2008</u> |
| Name of second inventor | Signature | Date |
| <u>Takuya HATAO</u> | <i>Takuya Hatao</i> | <u>November 28, 2008</u> |
| Name of third inventor | Signature | Date |